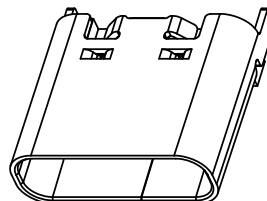
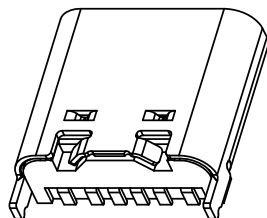
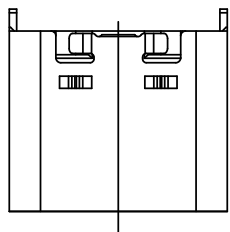


RoHS

目錄
MAPX

設變內容
MODIFICATION

日期
DATE



NOTE:

1.MATERIAL SPECIFICATION:

- 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
- 2.CONTACTS:COPPER ALLOY
- 3.MID PLATE: STAINLESS STEEL
- 4.FRONT SHELL: STAINLESS STEEL

2.PLATING SPECIFICATION:

2-1.CONTACTS:

Ni 50u" MIN. UNDER PLATED OVER ALL.

Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.

(GOLD PLATING THICKNESS FOLLOW THE P/N)

PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N

2-2.FRONT SHELL:

SEE TABLE1.

2-3.SHIELD PLATE&EMI PLATE:

CLEAR ONLY

3.MECHANICAL PERFORMANCE,

3-1.INSERTION FORCE: 0.5~2.0kgf.

3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.

3-3.DURABILITY: 5000 CYCLES.

4.ELECTRICAL PERFORMANCE,

4-1. CURRENT RATING:3.0A

VOLTAGE RATING:5.0V

4-2. LLCR:

VBUS & GND PINS AND OTHER PINS: 40m?/PIN MAX.

SHIELD: 50m?/MAX.

LLCR MAX. CHANGE OF ALL PINS: 10m?.

4-3.INSULATION RESISTANCE: 100M? MIN

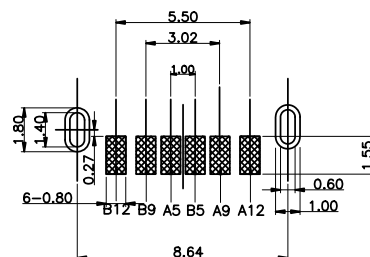
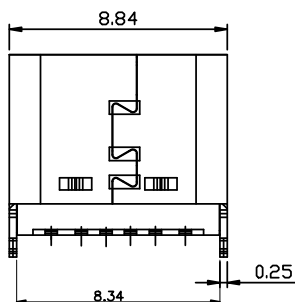
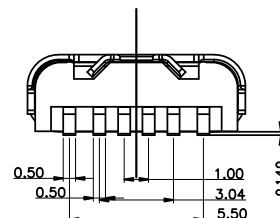
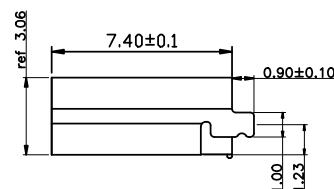
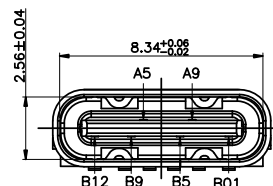
4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.

5. ENVIRONMENTAL PERFORMANCE:

OPERATING TEMPERATURE: -25°C~+85°C.

6.IR REFLOW:

THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260°C.



RECOMMENDED P.C.B. LAYOUT
TOLERANCE UNSPECIFIED ±0.05mm

PIN ASSIGNMENTS

A5	CC1	B12	GND
A9	VBUS	B9	VBUS
		B5	CC2
		B01	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE

X.	±0.35	X'.	±5"
.X	±0.30	.X"	±2"
.XX	±0.25	.XX"	±1"
.XXX	±0.10	.XXX"	±0.5"



深圳市精拓金电子有限公司
Shenzhen Jing Tuo Jin Electronics Co., Ltd.

单位 UNITS	MM	制图 DRAWING	Erick	产品料号 PRODUCT PART NO.	918-418K2022S40002
比例 SCALE	1:1	审核 CHKD	L S S	产品名称 PRODUCT NO.	TYPE-C3.1母座两脚立贴7.4LCP黑胶 6PIN
日期 DATE	2021/03/10	核准 APPD	黄国荣	角法 VIEW	版本 VER
					A0

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